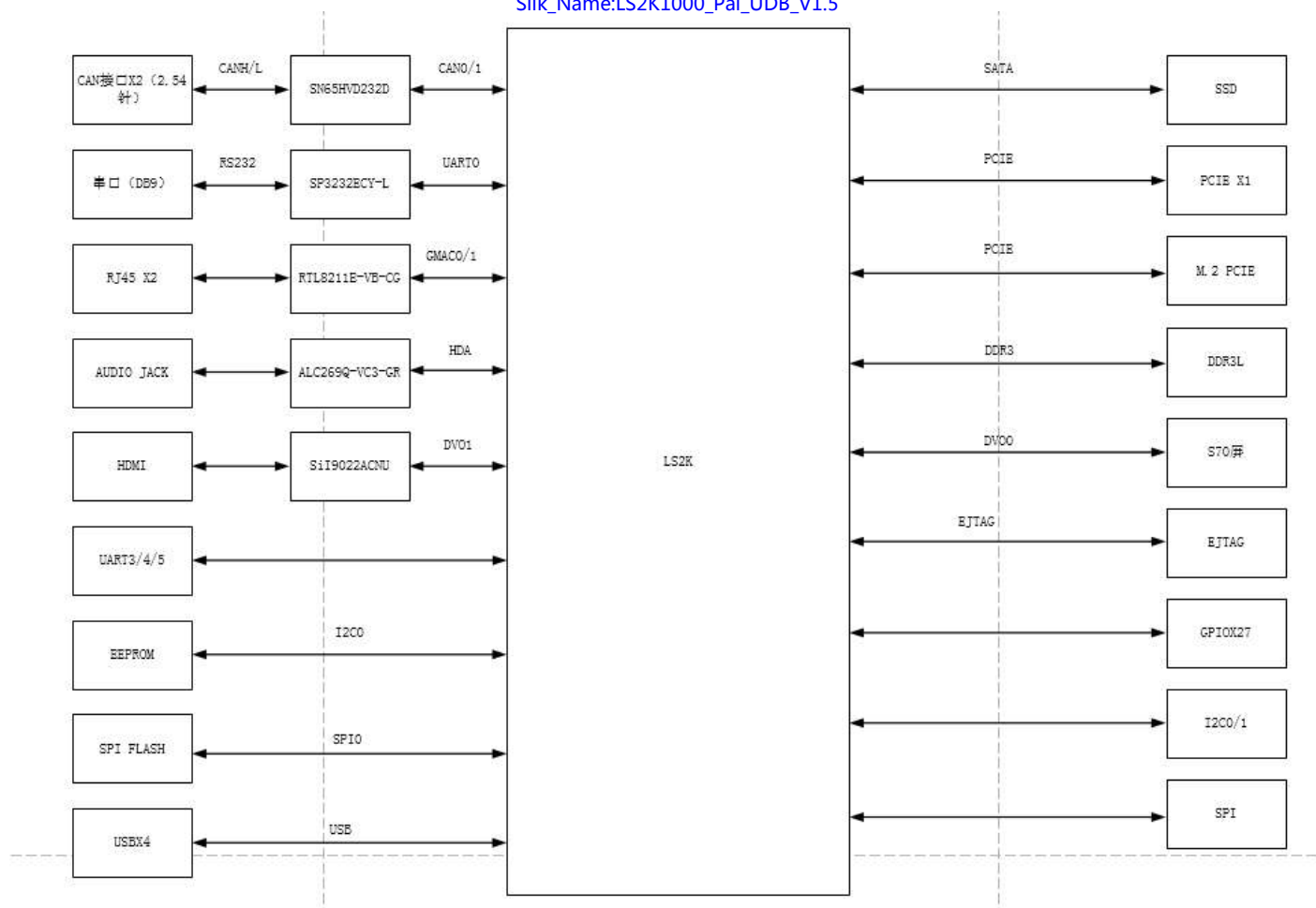


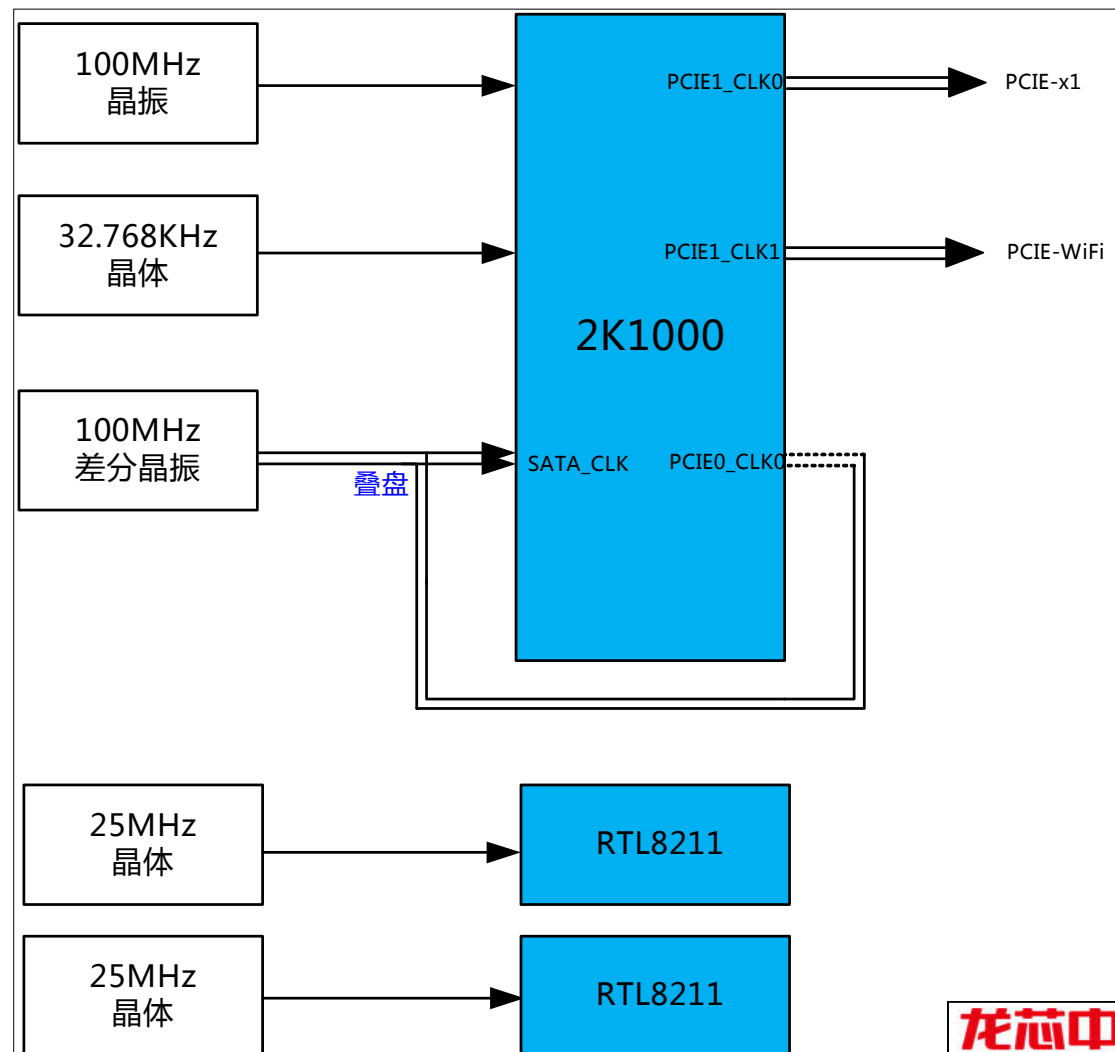
2K1000 Pai SYSTEM BLOCK

Board_Name:龙芯派-2K1000-Q
Silk_Name:LS2K1000_Pai_UDB_V1.5



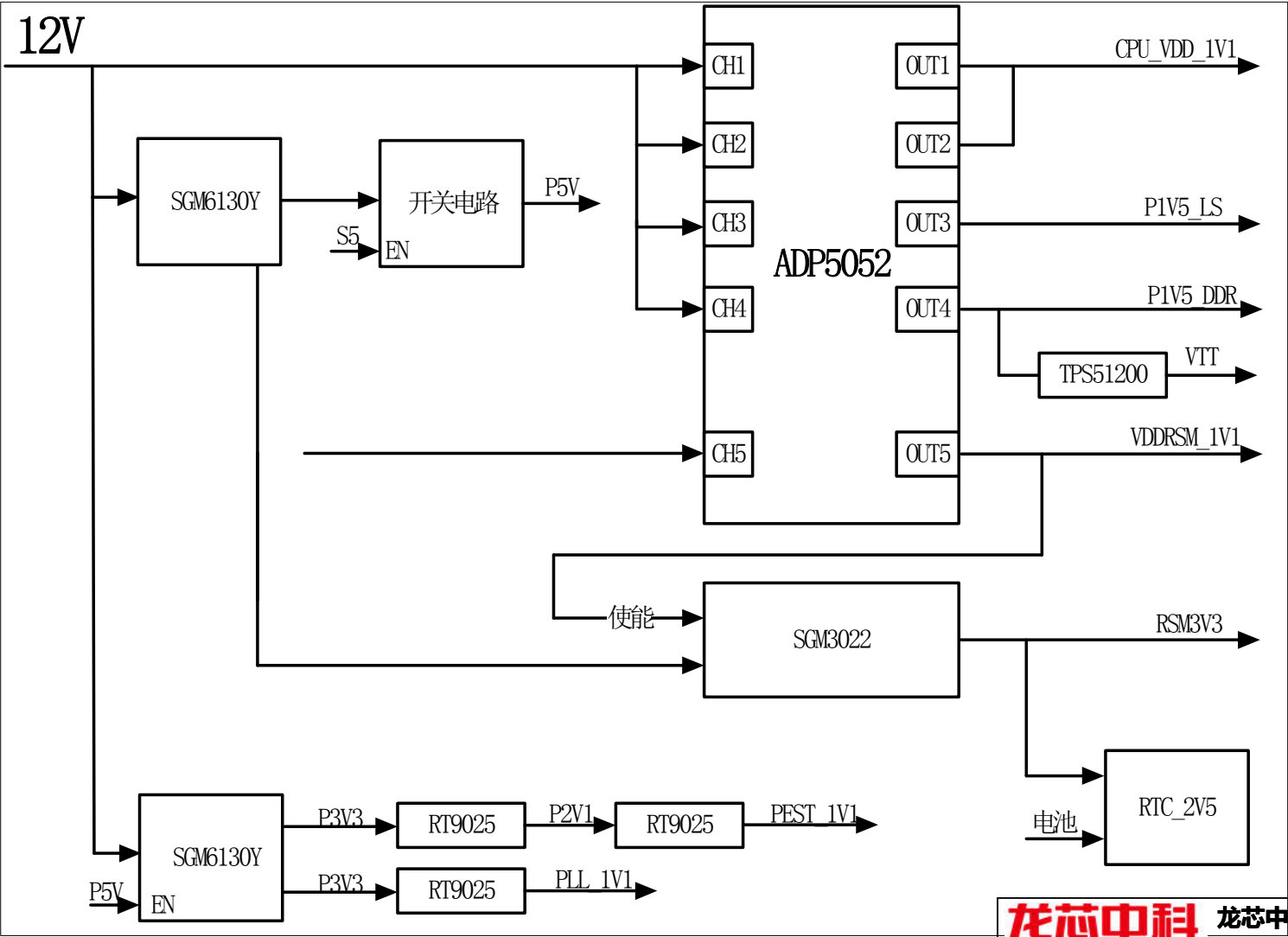
龙芯中科 <small>LONGSON TECHNOLOGY</small>		龙芯中科技术有限公司 <small>北京市海淀区稻香湖路中关村环保科技示范园龙芯产业园</small>	
板卡名称 龙芯派-2K1000-Q			
Size B	部门	嵌入式事业部	Rev V1.5
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CLOCK BLOCK



龙芯中科 LOONGSON TECHNOLOGY		龙芯中科技术有限公司 北京市海淀区稻香湖路中关村环保科技示范园龙芯产业园	
板卡名称 龙芯派-2K1000-Q			
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Drawn By 郭峰		Checked By 田社校	

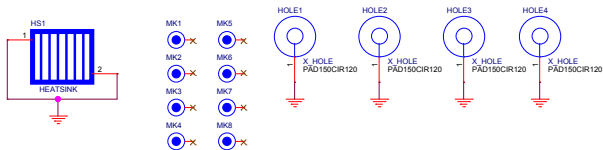
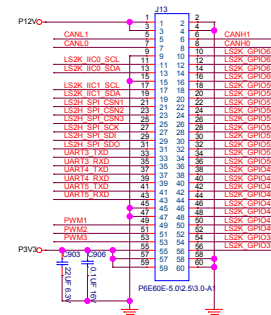
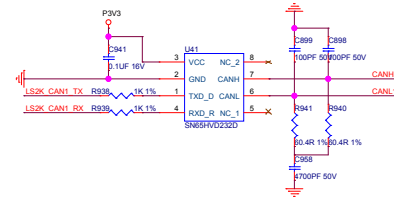
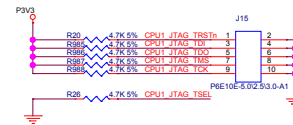
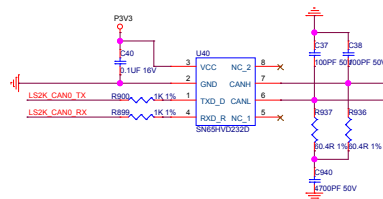
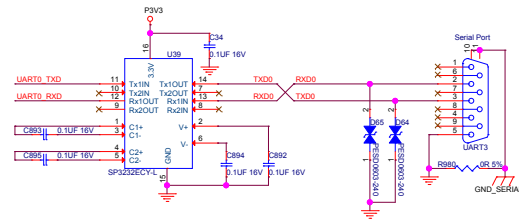
POWER BLOCK

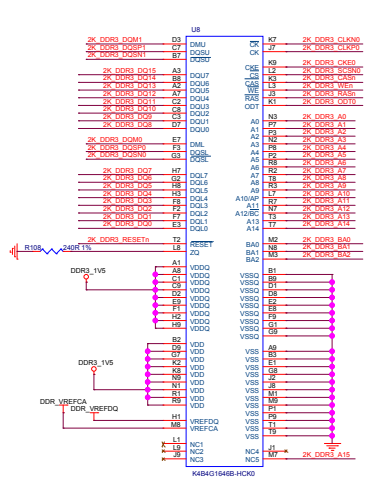


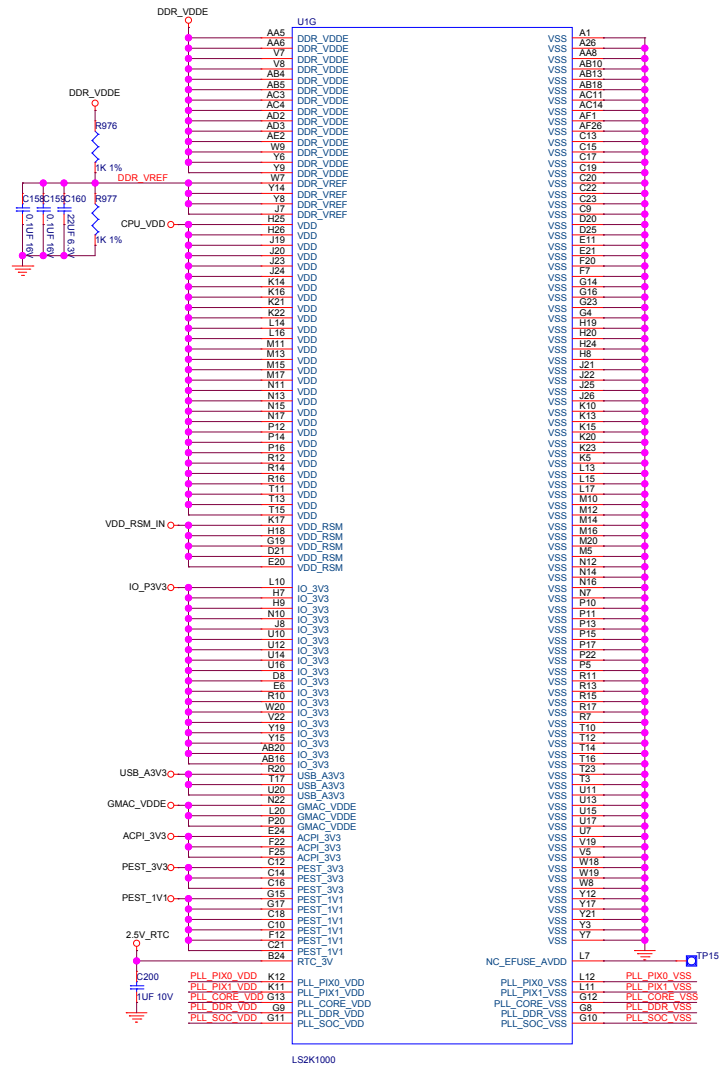
龙芯中科 LONGSON TECHNOLOGY		龙芯中科技术有限公司 北京市海淀区稻香湖路中关村环保科技示范园龙芯产业园	
板卡名称 龙芯派-2K1000-Q			
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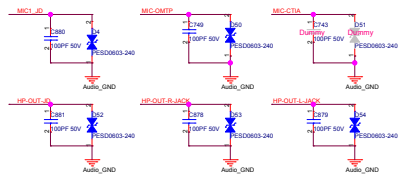
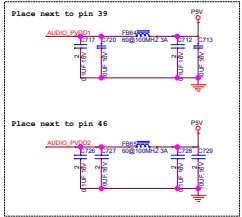
龙 芯 派-2K1000-Q

TITLE	PAGE
sysrem block	1
clk/reset# block	2
power_block	3
resource_spread	4
GPIO/I2S/EJTAG/SDIO/CAN	5
ACPI/I2C/SPI/PWM/URT/CFG	6
GMAC0/GPIO/USB	7
SSD/PCIE	8
DDR	9
DVO/HDMI/LIO	10
2K_POWER	11
AUDIO CODEC&CONN	12
BEEP	13
LAN0/1	14
1V1/1V2/1V5/3V3	15
RSM1V1/3V3	16
RESET#/PWR_BTN	17
BLANK	18

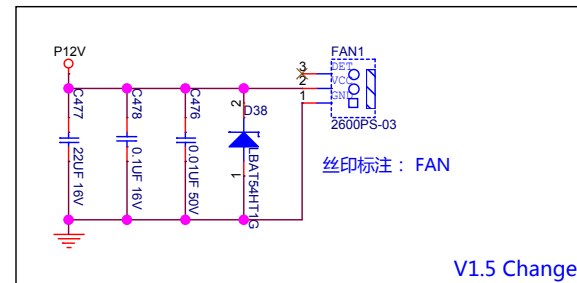
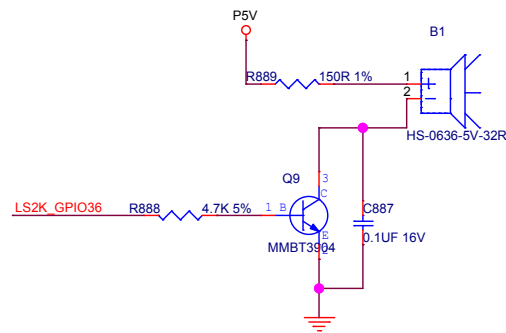






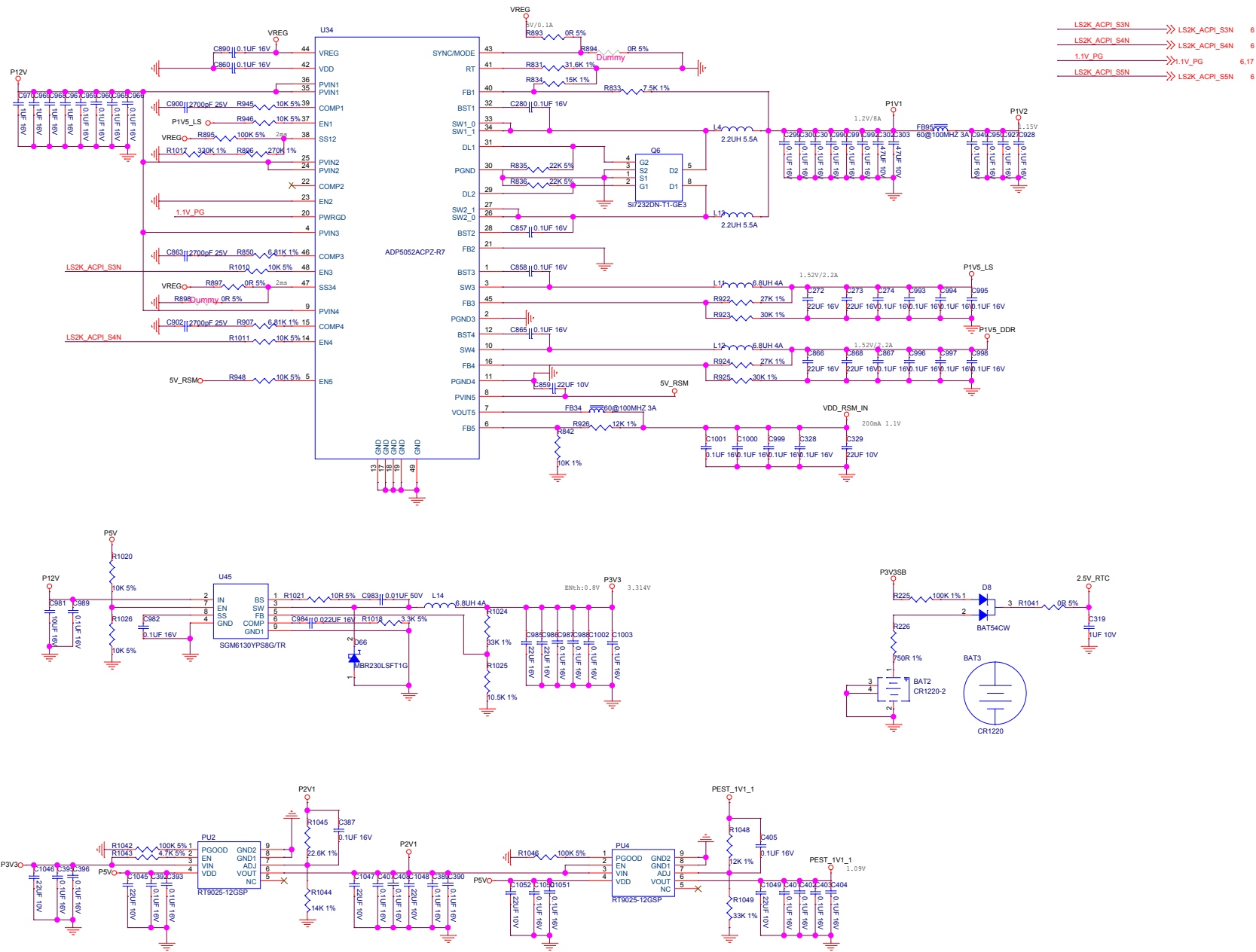


Change the ALC269's outout to HPOUT
Change the MIC's circuit
Dummy the MIC_JD's resistor
Change the HPOUT_JD's resistor to 39.2K

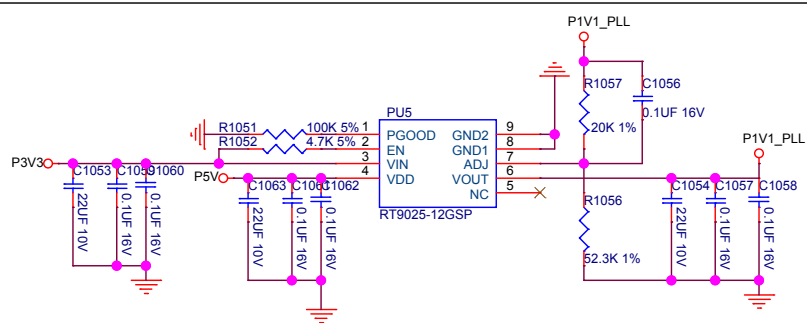
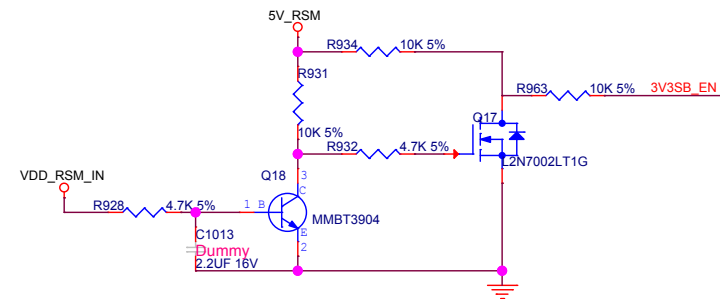
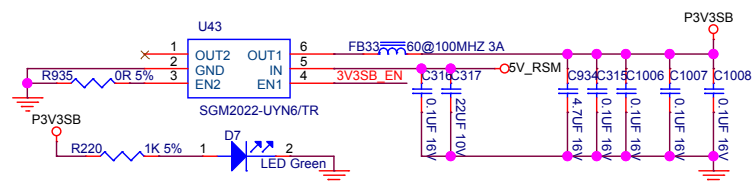
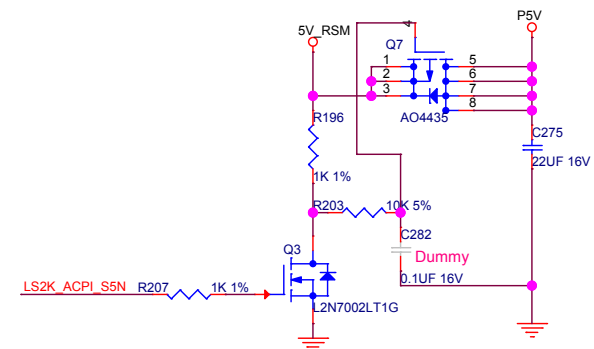
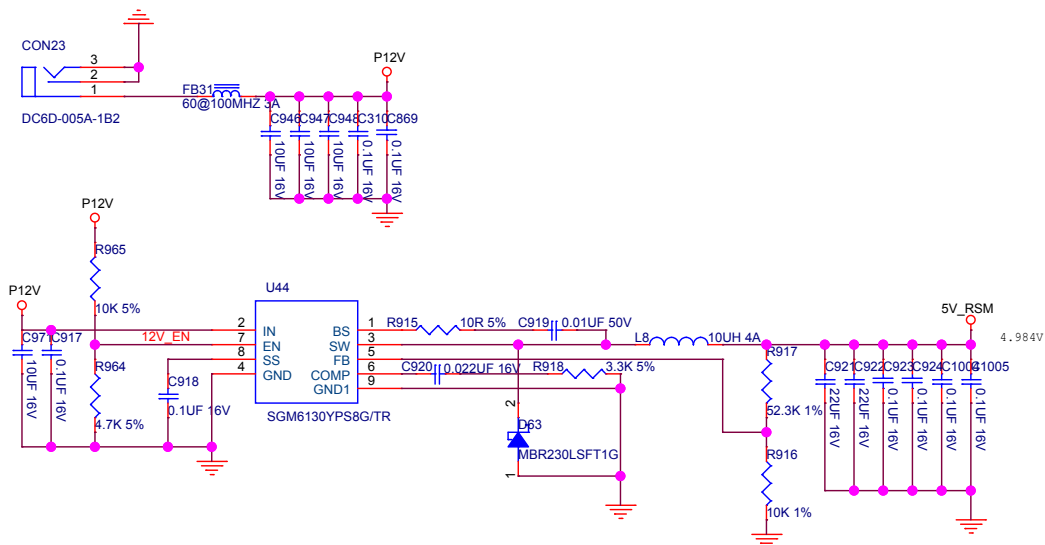


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LS2K_ACPI_S5N >> LS2K_ACPI_S5N 15



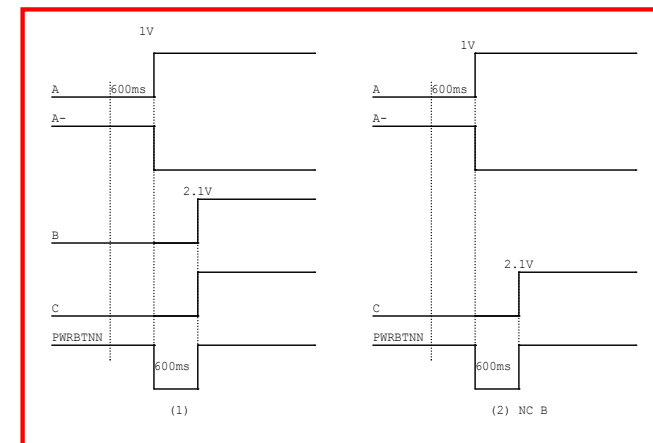
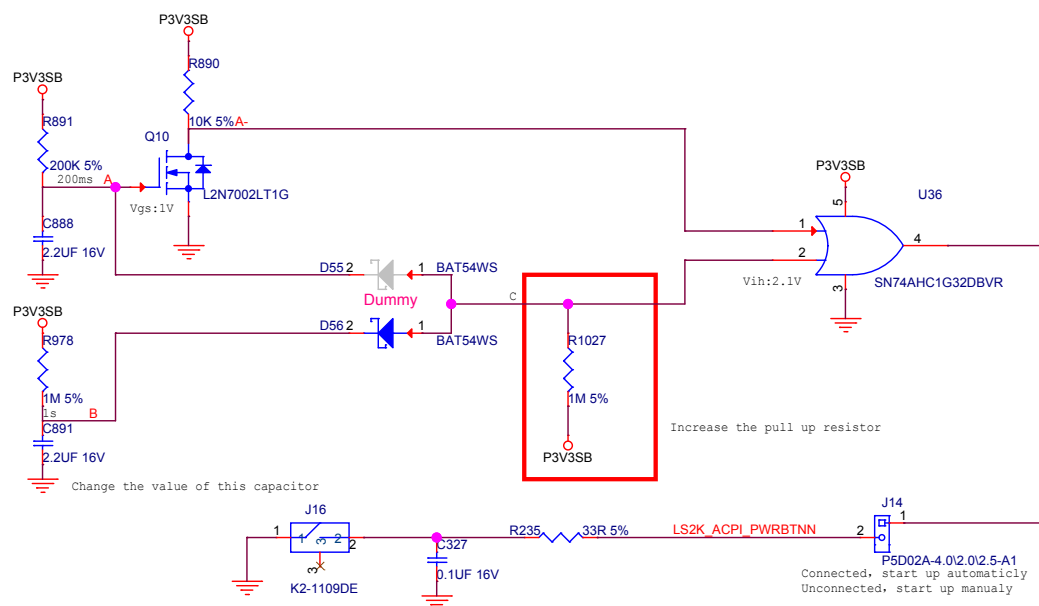
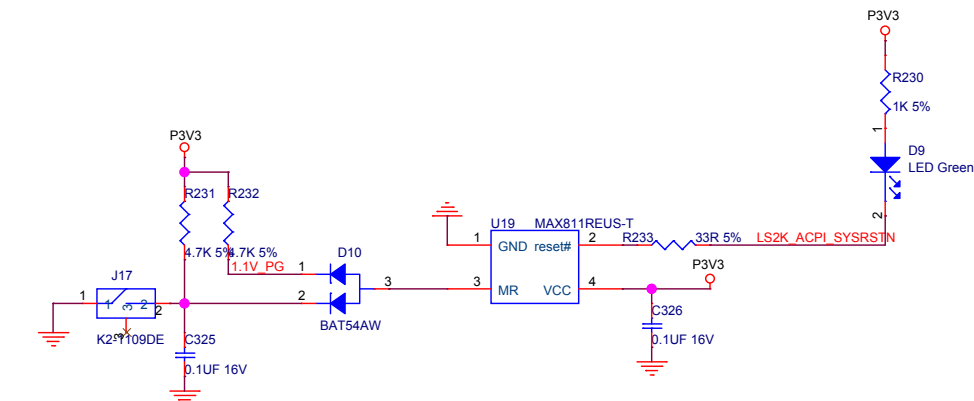
V1.5 Change

龙芯中科 龙芯中科技术有限公司 LONGSON TECHNOLOGY 北京市海淀区稻香湖路中关村环保科技示范园龙芯产业园			
板卡名称 龙芯派-2K1000-Q			
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LS2K_ACPI_SYSRSTN
1.1V_PG
LS2K_ACPI_PWRBTNN

LS2K_ACPI_SYSRSTN
1.1V_PG
LS2K_ACPI_PWRBTNN

6
6,15
6



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Change history

- 1.del F1 20170812
- 2.LCD change 3.3V to 5V
3. Delete the SD card

- 4.Change the EJTAG pin to the standard one
5. Change the OTG USB connector to the micro one
6. Change the HDMI connector to the standard one
7. Change the AUDIO Codec IC, and change the audio jack from two to one and delet its delay circuit
8. Increase the Beeper circuit and the power on start up circuit
9. Change the PHY chip and the internet connector to the standard one
- 10.CHange the 2.0,1.0,1.25pin to 2.54pin
- 11.Delete the touch IC ZT2083, and change the touch mode to 1-wire mode;
- 12.Increase the M.2 SATA, M.2 PCIE, and PCIE X1
- 13.The power scheme is changed,.Using the PMU of ADP5052 and the RT9018B-25GQW to generate the used voltage,delete the former used power IC
- 14.Change the power entry port from micro USB to the 5V adapter port
- 15.Increase one RS232 connector
- 16.Delete the wifi module
- 17.The PCB size is changed into 120mm*120mm
- 18.Increase the EEPROM.
- 19.Increase the heatsink package and 8 mark points
- 20.Connect the USB1 to PCIE WIFI connector
21. Delete the resistors of 15K on the USB circuit
- 22.Changed the 40pin into a 54pin one

2018.10.23

- 1.Change the value of R942,and increase the capicator of C976
- 2.Change U5 from W25X40BVSNIG to MD25D80CTIG
- 3.Change the order of SATA_TXP and SATA_TXN to the right order
- 5.Change the ALC 269's output pin to audiojack,and modify the mic circuit
- 6.Change the resistors that are conneted to the EN pins of ADP 5052
- 7.R225 is changed from 100K to 100R
- 8.Change the channel 1 andchannel 2 to parallel mode of ADP5052
- 9.P3V3 is generated by other circuit, the chip is SGM6130
- 10.Increase the pull up resistors to the W_DISABLE signals of PCIE WIFI
- 11.Increase the pull up resistor to the auto startup resistor
- 12.Change the ADP5052's inductance's footprint to small ones.

2019.06.18

- 1、R31改为1M
- 2、增加R1028/R1029\R1031\R1030\Q19\Q20\C1013
- 3、RTCRSMRSTN上拉改为P3V3SB
- 4、USB处的供电电源该为5VRSM
- 5、增加P3V3_SSD处的滤波电容
- 6、I2C1的信号接到HDMI接口处的I2C总线上，增加电平转换电路
- 7、去电U13、U14两个TVS管5脚上的电源
- 8、S5信号控制P5V的通断，S3信号控制DDR电源的使能。

2019.12.31 V1.4版本

- 1、新增PEST1V1_1的电源产生电路，该部分电路用于给2K的PEST1V1和PLL部分供电
- 2、修改给CPU_VDD供电的磁珠，同时该位置增加1个磁珠

2020.06.10 V1.5版本

- 1、新增PLL1V1_1的电源产生电路,该部分电路用于给2K的PLL部分供电（16页）
- 2、新增SATA 100M差分外部参考晶振（选焊,解决SATA概率性找不到问题）7页
- 3、修改多路电源的使能电阻，阻值10K，解决概率性不能上电问题（15页）
- 4、选焊掉C282防止上电5V有瞬间通电现象（16页）

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LONGSON TECHNOLOGY		北京市海淀区稻香湖路中关村环保科技示范园龙芯产业园	
板卡名称 龙芯 派-2K1000-Q			
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